TOSHIBA Power Transistor Module Silicon NPN Epitaxial Type (Darlington power transistor 4 in 1)

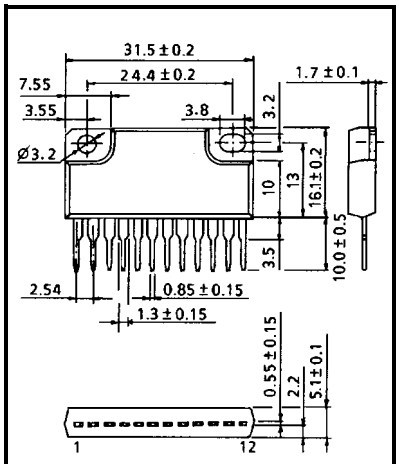
MP4501

Industrial Applications

High Power Switching Applications.

Hammer Drive, Pulse Motor Drive and Inductive Load Switching.

Unit: mm



TRANSISTOR PART		DIODE PART	
1, 5, 8, 12	BASE	2, 4, 9, 11	ANODE
2, 4, 9, 11	COLLECTOR	3, 10	CATHODE
6, 7	EMITTER		

JEDEC	—
JEITA	—
TOSHIBA	2-32B1A

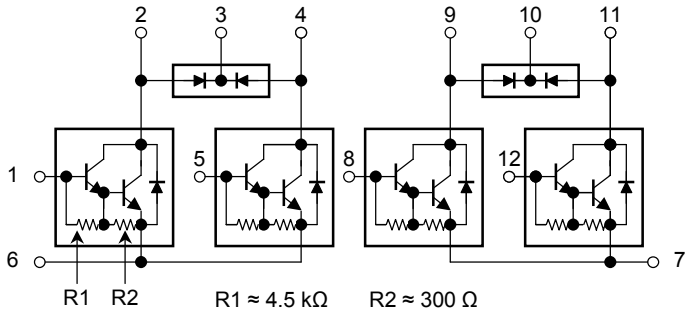
Weight: 6.0 g (typ.)

- Package with heat sink isolated to lead (SIP 12 pin)
- High collector power dissipation (4 devices operation)
  : P_T = 5 W (Ta = 25°C)
- High collector current: $I_{C\ (DC)}$ = 3 A (max)
- High DC current gain: h_{FE} = 2000 (min) (V_{CE} = 2 V, I_C = 1.5 A)
- Diode included for absorbing fly-back voltage.

Maximum Ratings (Ta = 25°C)

Characteristics		Symbol	Rating	Unit
Collector-base voltage		V_{CBO}	120	V
Collector-emitter voltage		V_{CEO}	100	V
Emitter-base voltage		V_{EBO}	6	V
Collector current	DC	I_C	3	A
	Pulse	I_{CP}	6	
Continuous base current		I_B	0.5	A
Collector power dissipation (1 device operation)		P_C	3.0	W
Collector power dissipation (4 devices operation)	Ta = 25°C	P_T	5.0	W
	Tc = 25°C		25	
Isolation voltage		V_{Isol}	1000	V
Junction temperature		T_j	150	°C
Storage temperature range		T_{stg}	−55 to 150	°C

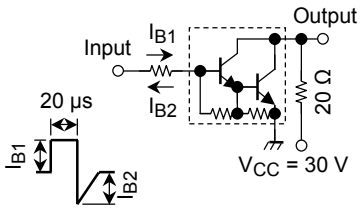
Array Configuration



Thermal Characteristics

Characteristics	Symbol	Max	Unit
Thermal resistance of junction to ambient (4 devices operation, Ta = 25°C)	$\Sigma R_{th\ (j\text{-}a)}$	25	°C/W
Thermal resistance of junction to case (4 devices operation, Tc = 25°C)	$\Sigma R_{th\ (j\text{-}c)}$	5.0	°C/W
Maximum lead temperature for soldering purposes (3.2 mm from case for 10 s)	T_L	260	°C

Electrical Characteristics (Ta = 25°C)

Characteristics		Symbol	Test Condition	Min	Typ.	Max	Unit
Collector cut-off current		I_{CBO}	V_{CB} = 120 V, I_E = 0 A	—	—	10	μA
Collector cut-off current		I_{CEO}	V_{CE} = 100 V, I_B = 0 A	—	—	10	μA
Emitter cut-off current		I_{EBO}	V_{EB} = 6 V, I_C = 0 A	0.5	—	2.5	mA
Collector-base breakdown voltage		$V_{(BR)\ CBO}$	I_C = 1 mA, I_E = 0 A	120	—	—	V
Collector-emitter breakdown voltage		$V_{(BR)\ CEO}$	I_C = 10 mA, I_B = 0 A	100	—	—	V
DC current gain		$h_{FE\ (1)}$	V_{CE} = 2 V, I_C = 1.5 A	2000	—	15000	—
		$h_{FE\ (2)}$	V_{CE} = 2 V, I_C = 3 A	1000	—	—	
Saturation voltage	Collector-emitter	$V_{CE\ (sat)}$	I_C = 1.5 A, I_B = 3 mA	—	—	1.5	V
	Base-emitter	$V_{BE\ (sat)}$	I_C = 1.5 A, I_B = 3 mA	—	—	2.0	
Transition frequency		f_T	V_{CE} = 2 V, I_C = 0.5 A	—	60	—	MHz
Collector output capacitance		C_{ob}	V_{CB} = 10 V, I_E = 0 A, f = 1 MHz	—	30	—	pF
Switching time	Turn-on time	t_{on}	 $I_{B1} = -I_{B2}$ = 3 mA, duty cycle ≤ 1%	—	0.3	—	μs
	Storage time	t_{stg}		—	2.0	—	
	Fall time	t_f		—	0.4	—	

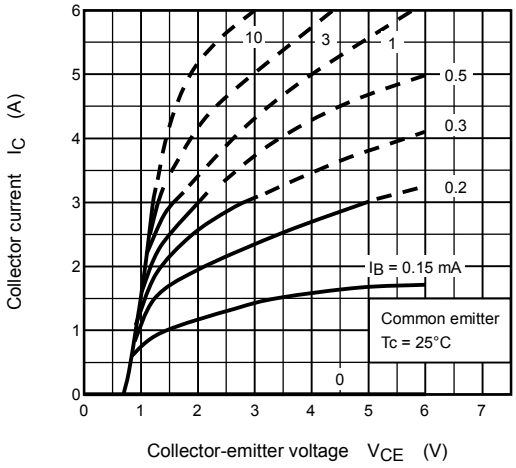
Emitter-Collector Diode Ratings and Characteristics (Ta = 25°C)

Characteristics	Symbol	Test Condition	Min	Typ.	Max	Unit
Maximum forward current	I_{FM}	—	—	—	3	A
Surge current	I_{FSM}	t = 1 s, 1 shot	—	—	6	A
Forward voltage	V_F	I_F = 1 A, I_B = 0 A	—	1.2	1.8	V
Reverse recovery time	t_{rr}	I_F = 3 A, V_{BE} = −3 V, dI_F/dt = −50 A/μs	—	1.0	—	μs
Reverse recovery charge	Q_{rr}		—	5	—	μC

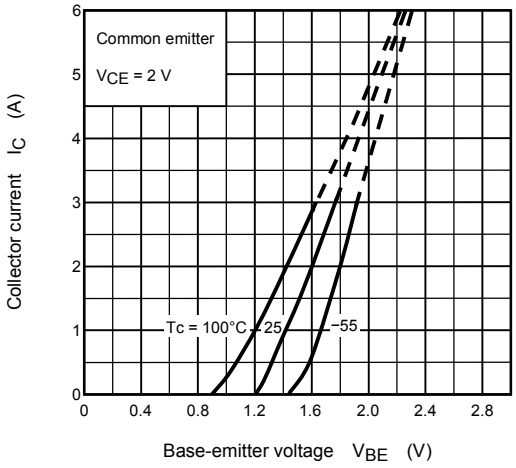
Flyback-Diode Rating and Characteristics (Ta = 25°C)

Characteristics	Symbol	Test Condition	Min	Typ.	Max	Unit
Maximum forward current	I_{FM}	—	—	—	3	A
Reverse current	I_R	V_R = 120 V	—	—	0.4	μA
Reverse voltage	V_R	I_R = 100 μA	120	—	—	V
Forward voltage	V_F	I_F = 0.5 A	—	—	1.8	V

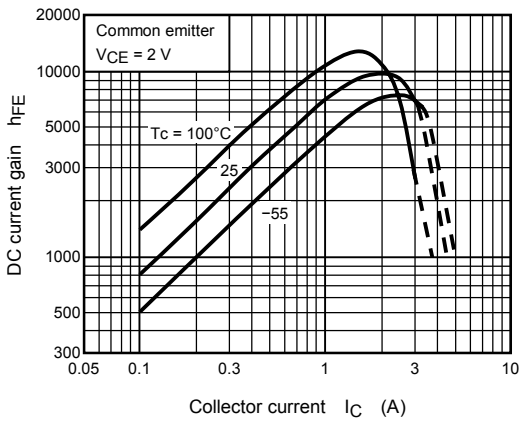
$I_C - V_{CE}$



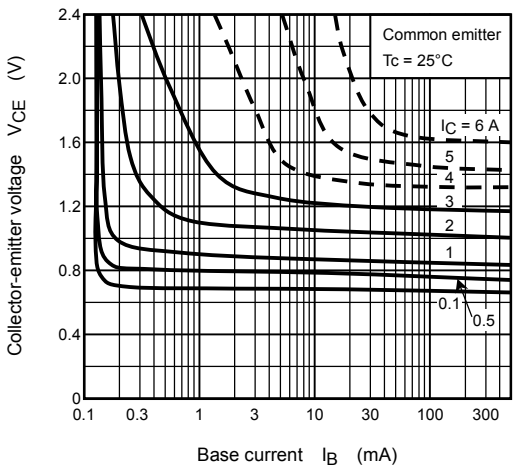
$I_C - V_{BE}$



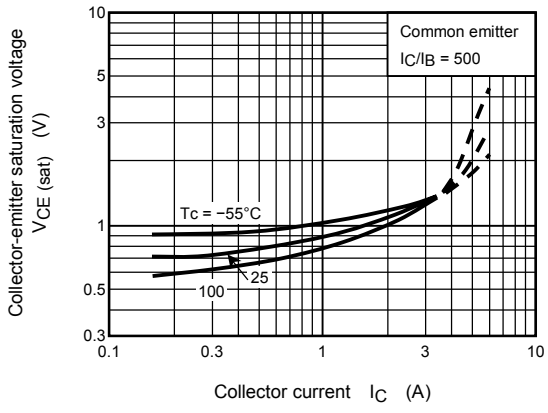
$h_{FE} - I_C$



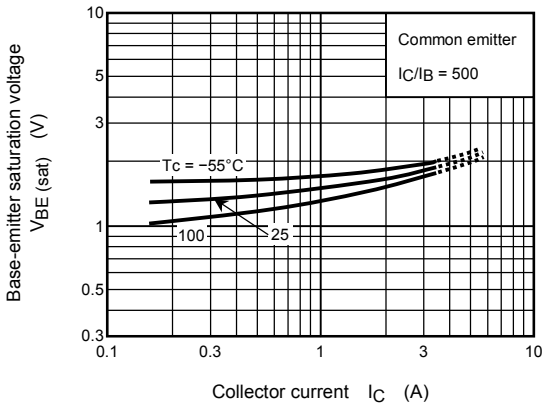
$V_{CE} - I_B$



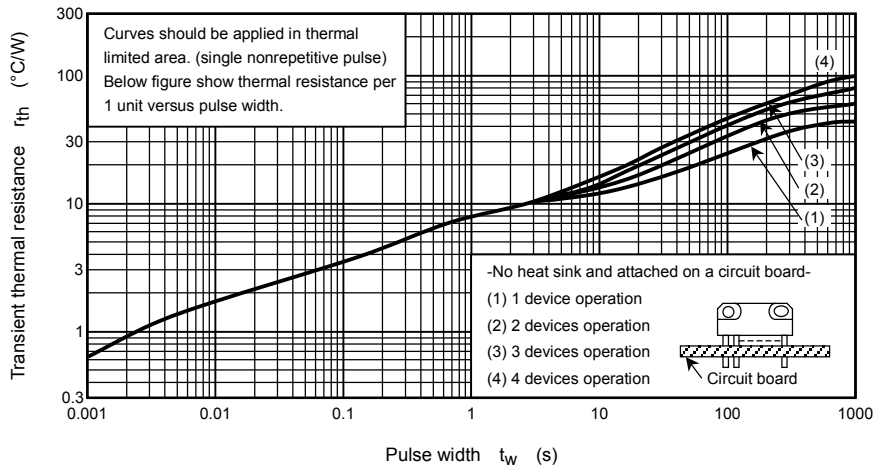
$V_{CE\ (sat)} - I_C$



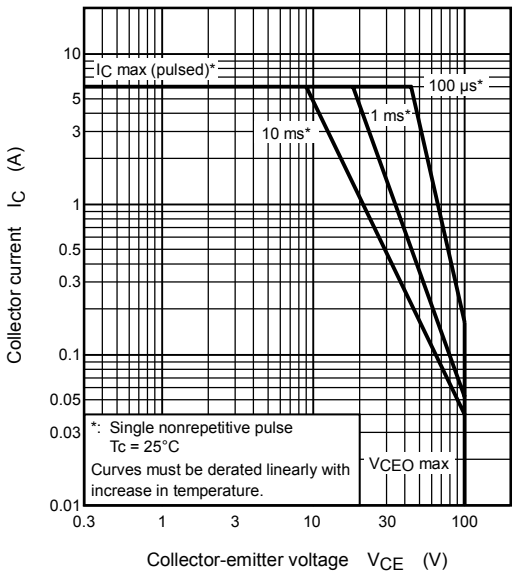
$V_{BE\ (sat)} - I_C$



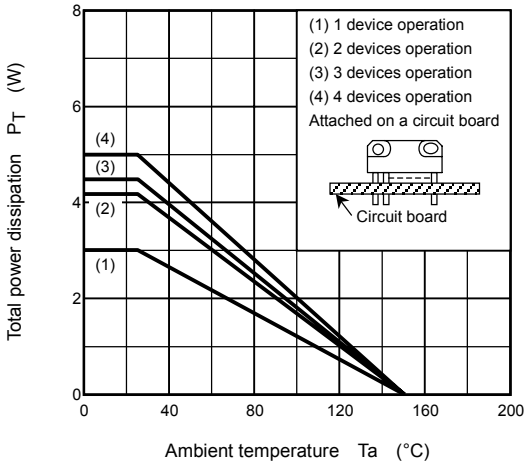
$r_{th} - t_w$



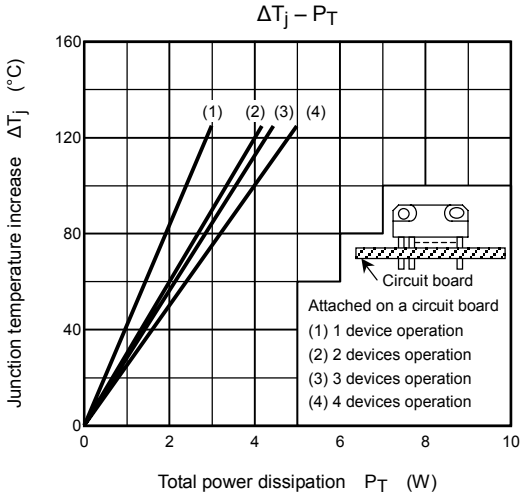
Safe Operating Area



P_T – Ta



$\Delta T_j - P_T$



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